

## **Vishay General Semiconductor**

## **Surface Mount Glass Passivated Ultrafast Rectifier**

## **Major Ratings and Characteristics**

I <sub>F(AV)</sub>	1.0 A
V <sub>RRM</sub>	50 V to 200 V
I <sub>FSM</sub>	30 A
t <sub>rr</sub>	50 ns
V <sub>F</sub>	1.0 V
T <sub>j</sub> max.	175 °C



Glass-plastic encapsulation technique is covered by patent No. 3,996,602, brazed-lead assembly by Patent No. 3,930,306 and lead forming by Patent No. 5,151,846

#### DO-214BA (GF1)

#### **Features**

- · Cavity-free glass-passivated junction
- · Ideal for automated placement
- · Ultrafast reverse recovery time
- · Low switching losses, high efficiency
- · High forward surge capability
- Meets environmental standard MIL-S-19500
- Meets MSL level 1, per J-STD-020C
- Solder Dip 260 °C, 40 seconds

#### **Mechanical Data**

Case: DO-214BA, molded epoxy over glass body

Epoxy meets UL-94V-0 Flammability rating

Terminals: Matte tin plated leads, solderable per

J-STD-002B and JESD22-B102D

E3 suffix for commercial grade, HE3 suffix for high

reliability grade (AEC Q101 qualified)

Polarity: Color band denotes cathode end

### **Typical Applications**

For use in high frequency rectification and freewheeling application in switching mode converters and inverters for consumer, computer, automotive and Telecommunication

#### **Maximum Ratings**

 $T_A = 25$  °C unless otherwise specified

Parameter	Symbol	EGF1A	EGF1B	EGF1C	EGF1D	Unit
Device Marking Code		EA	EB	EC	ED	
Maximum repetitive peak reverse voltage	$V_{RRM}$	50	100	150	200	V
Maximum RMS voltage	V <sub>RMS</sub>	35	70	105	140	V
Maximum DC blocking voltage	$V_{DC}$	50	100	150	200	V
Maximum average forward rectified current at T <sub>L</sub> = 125 °C	I <sub>F(AV)</sub>		Α			
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	30				Α
Operating junction and storage temperature range	$T_J, T_{STG}$	- 65 to + 175				°C

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# **EGF1A thru EGF1D**

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#### **Electrical Characteristics**

 $T_A = 25$  °C unless otherwise specified

Parameter	Test condition	Symbol	EGF1A	EGF1B	EGF1C	EGF1D	Unit
Maximum instantaneous forward	at 1.0 A	$V_{F}$	1.0				V
voltage (1)							
Maximum DC reverse current at	T <sub>A</sub> = 25 °C	I <sub>R</sub>	5.0				μΑ
rated DC blocking voltage (1)	T <sub>A</sub> = 125 °C		50				
Typical reverse recovery time	at $I_F = 0.5 \text{ A}$ , $I_R = 1.0 \text{ A}$ , $I_{rr} = 0.25 \text{ A}$	t <sub>rr</sub>	50			ns	
Typical junction capacitance	at 4.0 V, 1 MHz	$C_J$	15			pF	

#### Notes:

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

## **Thermal Characteristics**

 $T_A = 25$  °C unless otherwise specified

Parameter	Symbol	EGF1A	EGF1B	EGF1C	EGF1D	Unit
Typical thermal resistance (1)	$R_{\theta JA}$	85				°C/W
	$R_{\theta JL}$	30				

#### Notes:

(1) Thermal resistance from junction to ambient and from junction to lead, P.C.B. mounted on 0.2 x 0.2" (5.0 x 5.0 mm) copper pad areas

## **Ratings and Characteristics Curves**

(T<sub>A</sub> = 25 °C unless otherwise specified)

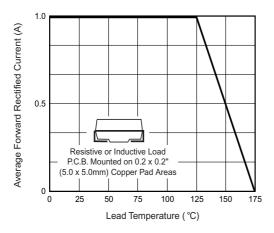


Figure 1. Maximum Forward Current Derating Curve

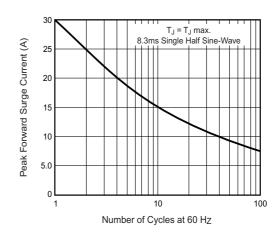


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current



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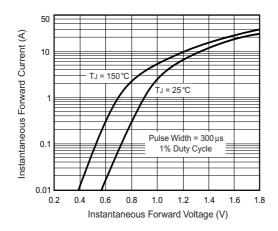


Figure 3. Typical Instantaneous Forward Characteristics

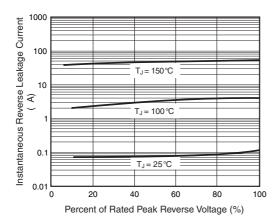


Figure 4. Typical Reverse Leakage Characteristics

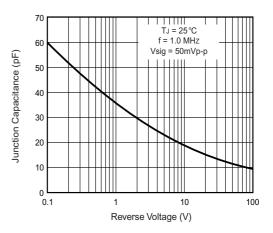


Figure 5. Typical Junction Capacitance

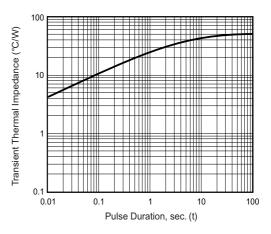
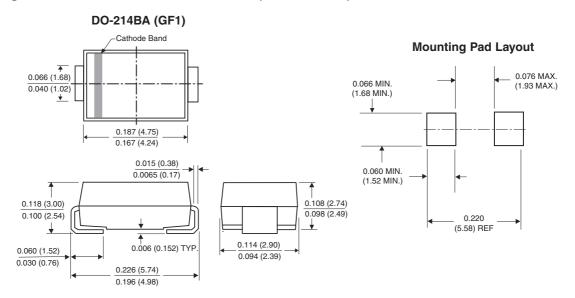


Figure 6. Typical Transient Thermal Impedance

## Package outline dimensions in inches (millimeters)



## **Legal Disclaimer Notice**



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